

#	Layer	Thickness	Description	Dk	Df	Note
	Top Solder	0.015mm	Soldermask IPC-SM840	3,5	0,028	used on rigid parts
1	Top Side	0.030mm	Starting foil 1/4oz. after plating and processing			
		0.065mm	Prepreg IPC-4101/127/128	3,5	0,011	FR-4.1 filled, halogen free
2	Inner Layer 1	0.017mm	ED Base Copper			
		0.510mm	Core IPC-4101/127/128	5,1	0,011	FR-4.1 filled, halogen free
3	Inner Layer 2	0.017mm	ED Base Copper			
		0.125mm	Prepreg IPC-4101/127/128	3,7	0,011	FR-4.1 filled, halogen free
4	Inner Layer 3	0.017mm	ED Base Copper			
		0.510mm	Core IPC-4101/127/128	5,1	0,011	FR-4.1 filled, halogen free
5	Inner Layer 4	0.017mm	ED Base Copper			
		0.065mm	Prepreg IPC-4101/127/128	3,5	0,011	FR-4.1 filled, halogen free
6	Bottom Side	0.030mm	Starting foil 1/4oz. after plating and processing			
	Bottom Solder	0.015mm	Soldermask IPC-SM840	3,5	0,028	used on rigid parts
<b>Total thickness: 1.433mm</b>						

Würth Elektronik GmbH & Co. KG  
Circuit Board Technology

notes:

Final copper thickness according to IPC-6012

Please regard to our sectional design rules:  
► [www.we-online.com](http://www.we-online.com)

<b>HDI6_1-4-1_1,43_17_V2.12</b>			
PCB Thickness Tolerance: ± 10%			
customer		created	
pcb name		approved	
engineer		format	A4, landscape
date			
Template Revision: 02/2021 by Andreas Schilpp / Michael Kress / Werner Öchslen			

